OPERATING	APPLICA	BLE STAN	DARD											
RATING				S ⁻										
RATING VOLTAGE		-		-55 °C TO 85 °C (1)						-10 °	С ТО	60 °C	(2)	
CURRENT 3.4 (MF CONTACT) 0 RANGE RELATIVE HUMDITY 95% max (NOT DEWED)	RATING	VOLTAGE		100 V AC	100 V AC			ANGE			40 % TO 70			
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